



# P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ )	I <sub>D</sub> (A) <sup>a, e</sup>	Q <sub>g</sub> (Typ.)			
- 30	0.042 at V <sub>GS</sub> = - 10 V	- 6	7 nC			
- 30	$0.072$ at $V_{GS} = -4.5 \text{ V}$	- 6	7110			

### **FEATURES**

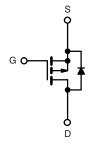
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC



**FREE** 

### **APPLICATIONS**

- Load Switch
- Notebook Adaptor Switch



P-Channel MOSFET

	SO-8		
S 1		8	D
S 2		7	D
S 3		6	D
G 4		5	D
	Top View	_	

Ordering Information: Si4485DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		- 6 <sup>e</sup>		
Continuous Prain Current (T = 150 °C)	T <sub>C</sub> = 70 °C		- 6 <sup>e</sup>		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 5.9 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 4.7 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	- 25		
Continous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1	- 4.2		
Continues Source-Diam Diode Current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	- 2 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		5		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	ь	3.2	w	
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.4 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		1.5 <sup>b, c</sup>		
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	$R_{thJA}$	42	53	°C/W		
Maximum Junction-to-Foot (Drain) Steady State		$R_{thJF}$	19	25	O/ <b>VV</b>		

#### Notes:

- a. Based on  $T_C = 25$  °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.
- e. Package Limited.

## **Si4485DY**

# Vishay Siliconix



<b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}C$ , Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Cymbol	rest conditions		iyp.	IVIAA.	Oille	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 19		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = - 250 μA		4.4			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = -250 \mu\text{A}$	- 1.2		- 2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
<u> </u>		V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			- 5	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α	
	Б	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5.9 A		0.035	0.042		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.5 A		0.060	0.072	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5.9 A		10		S	
Dynamic <sup>b</sup>				•	•		
nput Capacitance	C <sub>iss</sub>			590			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		115		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	]		93			
Fotal Cata Charge	Qg	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -5.9 A		13.6	21	nC	
Total Gate Charge				7	11		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5.9 \text{ A}$		2.3			
Gate-Drain Charge	$Q_{gd}$			3.2			
Gate Resistance	$R_g$	f = 1 MHz	1	5	10	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			30	45		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 3.2 $\Omega$		25	38		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong -4.7 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		16	24		
Fall Time	t <sub>f</sub>			8	16	200	
Turn-On Delay Time	t <sub>d(on)</sub>			8	16	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 3.2 $\Omega$		10	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 4.7 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		18	27		
Fall Time	t <sub>f</sub>	]		8	16		
Drain-Source Body Diode Characteristi	cs			•	•		
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.2	۸	
Pulse Diode Forward Current	I <sub>SM</sub>				- 25	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 4.7 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			17	26	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 4.7 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C		9	18	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	1 1F = -4.7 A, αι/αι = 100 A/μs, 1J = 25 °C		10		ne	
Reverse Recovery Rise Time t <sub>b</sub>		]		7		ns	

### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

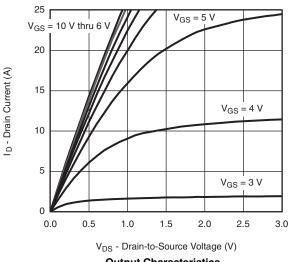
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

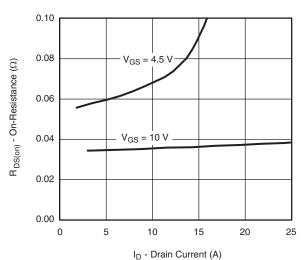




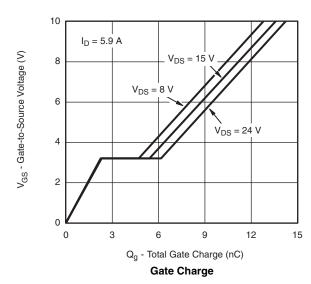
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

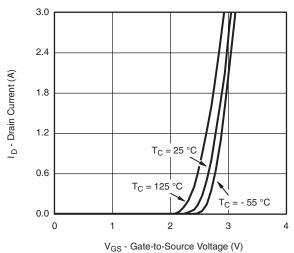




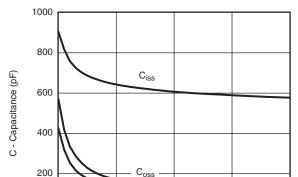


On-Resistance vs. Drain Current





**Transfer Characteristics** 



 $\mathsf{C}_{\mathsf{rss}}$ 

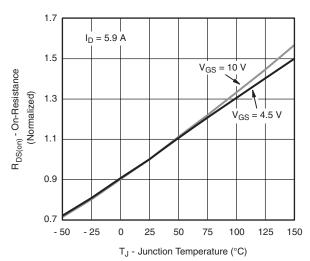
5

0

0

10 V<sub>DS</sub> - Drain-to-Source Voltage (V)

### Capacitance



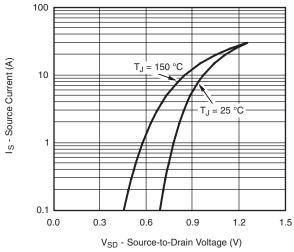
On-Resistance vs. Junction Temperature

20

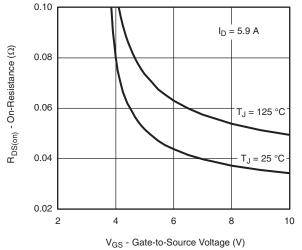
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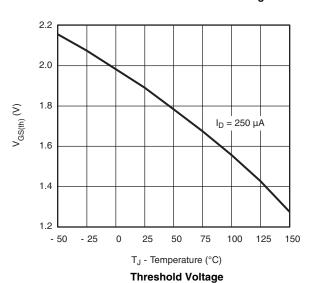
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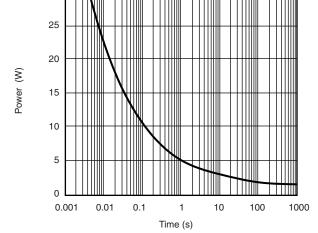


Source-Drain Diode Forward Voltage



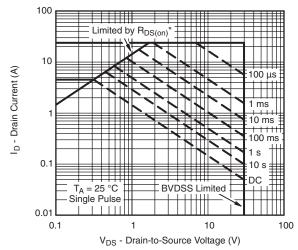
On-Resistance vs. Gate-to-Source Voltage





30

Single Pulse Power (Junction-to-Ambient)

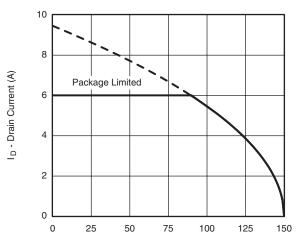


\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient

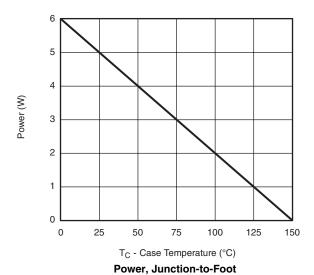


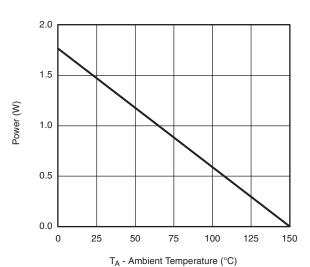
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $T_C$  - Case Temperature (°C)

### **Current Derating\***





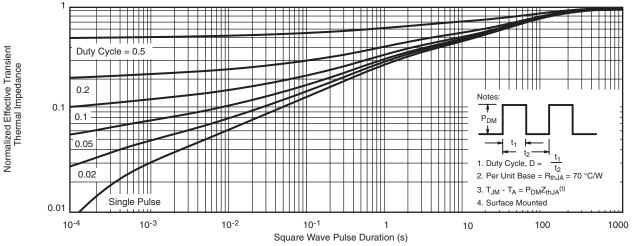
Power, Junction-to-Ambient

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

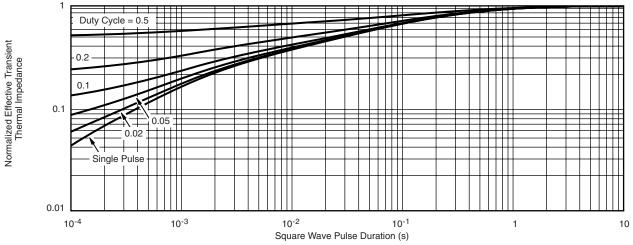
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

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### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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